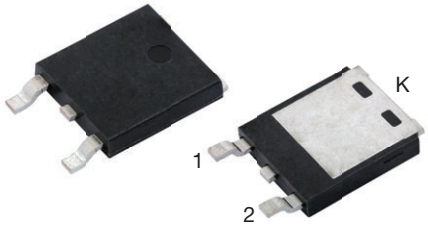
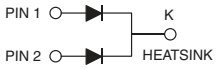
# High Current Density Surface Mount Trench MOS Barrier Schottky Rectifier

Ultra Low $V_F$ = 0.60 V at $I_F$ = 5 A

**TMBS® eSMP® Series**




**SlimDPAK (TO-252AE)**




## FEATURES

- Very low profile - typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT HALOGEN FREE

## TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

## MECHANICAL DATA

**Case:** SlimDPAK (TO-252AE)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meets JESD 201 class 2 whisker test

| PRIMARY CHARACTERISTICS | |
|---|---|
| $I_{F(AV)}$ | 40 A |
| $V_{RRM}$ | 150 V |
| $I_{FSM}$ | 240 A |
| $V_F$ at $I_F$ = 20 A ($T_A$ = 125 °C) | 0.76 V |
| $T_J$ max. | 150 °C |
| Package | SlimDPAK (TO-252AE) |
| Circuit configuration | Common cathode |

**MAXIMUM RATINGS** ($T_A$ = 25 °C unless otherwise noted)

| PARAMETER | | SYMBOL | V40PW15C | UNIT |
|---|---|---|---|---|
| Device marking code | | | V40PW15C | |
| Maximum repetitive peak reverse voltage | | $V_{RRM}$ | 150 | V |
| Maximum average forward rectified current (fig. 1) | per device | $I_{F(AV)}$ (1) | 40 | A |
| | per diode | $I_{F(AV)}$ (1) | 20 | A |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | | $I_{FSM}$ | 240 | A |
| Operating junction temperature range | | $T_J$ (2) | -40 to +150 | °C |
| Storage temperature range | | $T_{STG}$ | -55 to +150 | °C |

**Notes**

(1) With infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

| **ELECTRICAL CHARACTERISTICS** ($T_A$ = 25 °C unless otherwise noted) | | | | | | |
|---|---|---|---|---|---|---|
| **PARAMETER** | **TEST CONDITIONS** | | **SYMBOL** | **TYP.** | **MAX.** | **UNIT** |
| Maximum instantaneous forward voltage | $I_F$ = 5.0 A | $T_A$ = 25 °C | $V_F$ (1) | 0.77 | - | V |
| | $I_F$ = 10 A | | | 0.97 | - | |
| | $I_F$ = 20 A | | | 1.36 | 1.45 | |
| | $I_F$ = 5.0 A | $T_A$ = 125 °C | | 0.6 | - | |
| | $I_F$ = 10 A | | | 0.69 | - | |
| | $I_F$ = 20 A | | | 0.76 | 0.84 | |
| Reverse current | $V_R$ = 100 V | $T_A$ = 25 °C | $I_R$ (2) | 0.01 | - | mA |
| | | $T_A$ = 125 °C | | 3 | - | |
| | $V_R$ = 150 V | $T_A$ = 25 °C | | - | 0.5 | |
| | | $T_A$ = 125 °C | | 6 | 20 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | $C_J$ | 870 | - | pF |

**Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

| **THERMAL CHARACTERISTICS** ($T_A$ = 25 °C unless otherwise noted) | | | |
|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **V40PW15C** | **UNIT** |
| Typical thermal resistance | $R_{\theta JA}$ (1)(2) | 55 | °C/W |
| | $R_{\theta JM}$ (3) | 1.5 | |

**Notes**

(1) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

(3) Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ - junction-to-mount

| **ORDERING INFORMATION** (Example) | | | | |
|---|---|---|---|---|
| **PREFERRED P/N** | **UNIT WEIGHT (g)** | **PREFERRED PACKAGE CODE** | **BASE QUANTITY** | **DELIVERY MODE** |
| V40PW15C-M3/I | 0.20 | I | 4500 | 13" diameter plastic tape and reel |
| V40PW15CHM3/I (1) | 0.20 | I | 4500 | 13" diameter plastic tape and reel |

**Note**

(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES ($T_A$ = 25 °C unless otherwise noted)

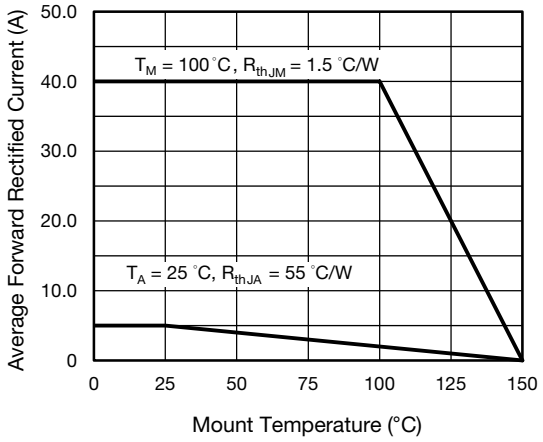



Fig. 1 - Maximum Forward Current Derating Curve

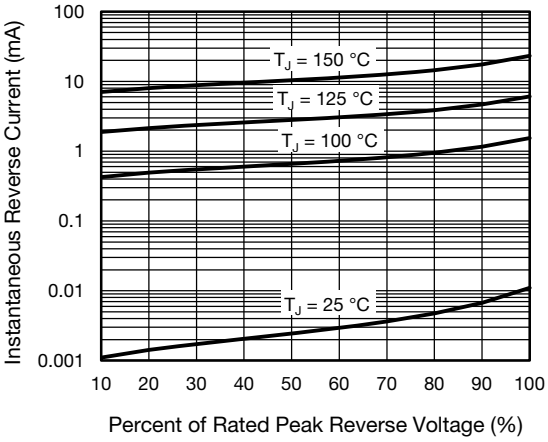



Fig. 4 - Typical Reverse Leakage Characteristics

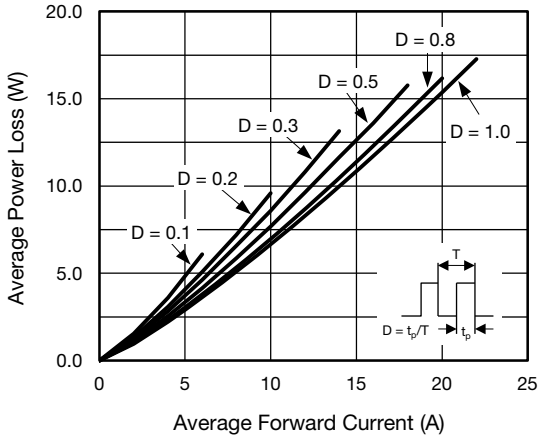



Fig. 2 - Forward Power Loss Characteristics

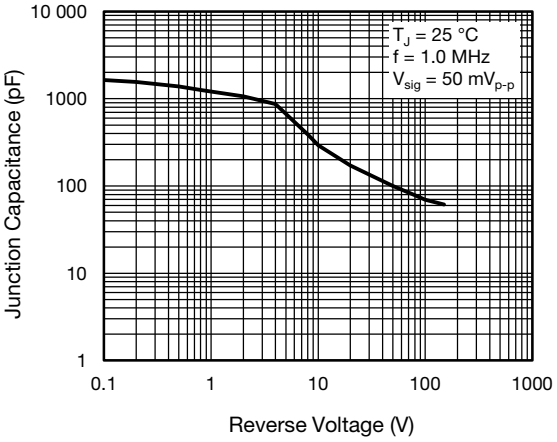



Fig. 5 - Typical Junction Capacitance

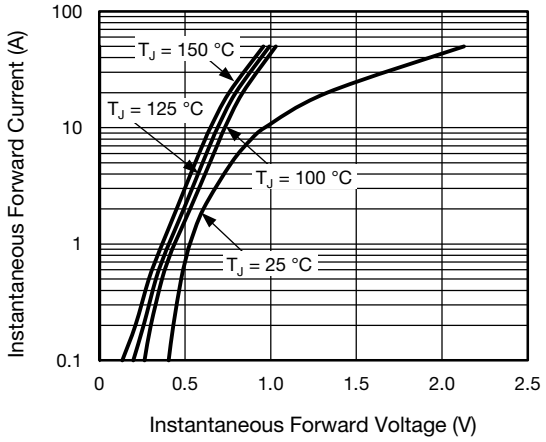



Fig. 3 - Typical Instantaneous Forward Characteristics

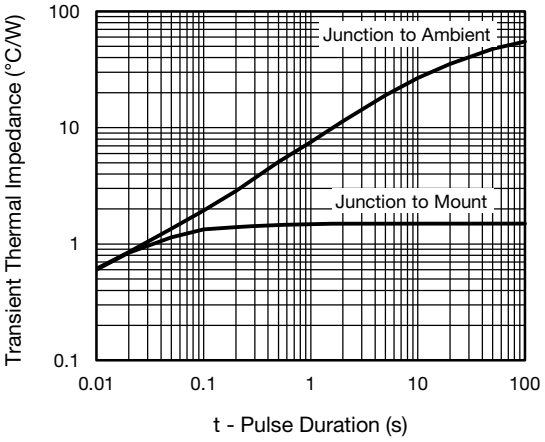



Fig. 6 - Typical Transient Thermal Impedance

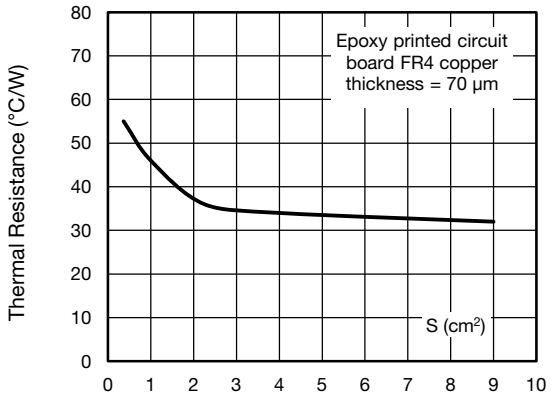



Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

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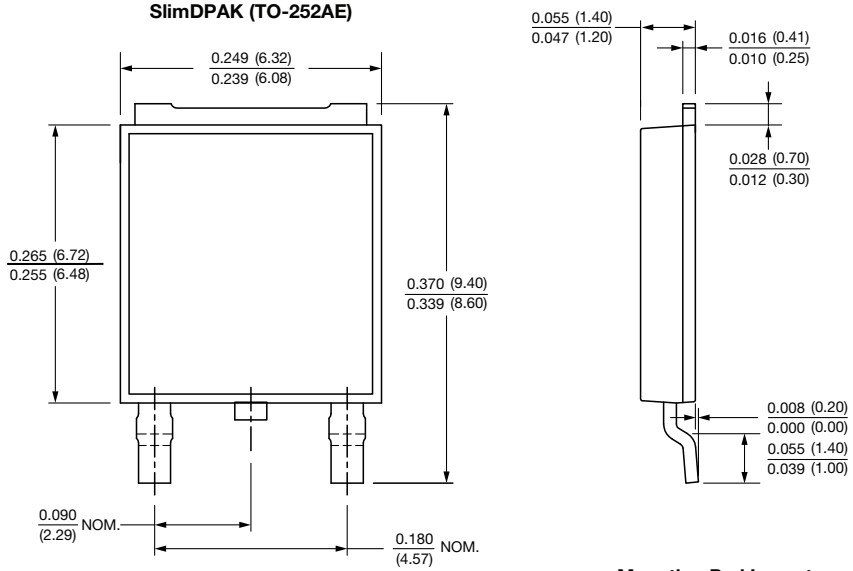
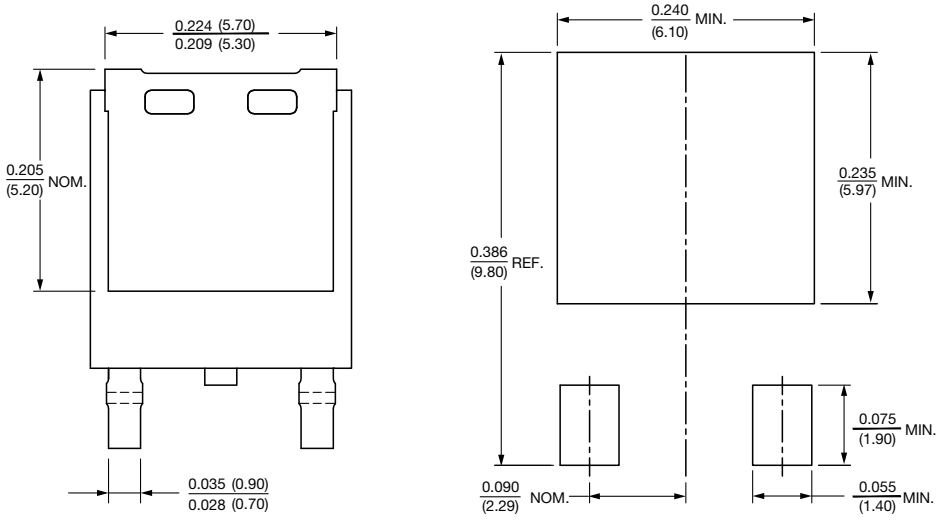



**Mounting Pad Layout**



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